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Dual D-type Flip Flops with Preset and Clear



ADE-205-066C(Z)

Rev.3 September 1995

Description

The HD74LVC74 has independent data, preset, clear, and clock inputs Q and \overline{Q} outputs in a 14 pin package. The logic level present at the data input is transferred to the output during the positive going transition of the clock pulse. Preset and clear are independent of the clock and accomplished by a low level at the appropriate input. Low voltage and high speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

Features

- $V_{cc} = 2.0 \text{ V to } 5.5 \text{ V}$
- All inputs V_{H} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- Typical V_{OL} ground bounce < 0.8 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.0 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- High output current ± 24 mA (@V_{cc} = 3.0 V to 5.5 V)

Function Table

Inputs				Outputs	
PR	CLR	СК	D	Q	Q
L	Н	Х	Х	Н	L
Н	L	Х	Х	L	Н
L	L	Х	Х	H *1	H *1
Н	Н	↑	Н	Н	L
Н	Н	↑	L	L	Н
Н	Н	L	Х	$Q_{_0}$	$\overline{Q}_{\scriptscriptstyle{0}}$
Н	Н	Н	Х	$Q_{_{0}}$	$\overline{Q}_{_{\!\scriptscriptstyle{0}}}$
Н	Н	\	Х	$Q_{_{0}}$	$\overline{Q}_{_{0}}$

H: High level

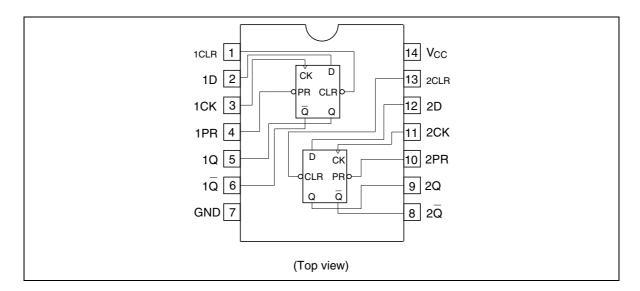
L: Low level X: Immaterial

↓: High to Low transition↑: Low to high transition

 Q_0 : Level to Q before the indicated steady input conditions were established.

Note: 1. Q and \overline{Q} will remain high as long as preset and clear are low, but Q and \overline{Q} are unpredictable, if preset and clear go high simultaneously.

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol Ratings		Unit	Conditions		
Supply voltage	V _{cc}	-0.5 to 6.0	V			
Input diode current	I _{IK}	– 50	mA	V ₁ = -0.5 V		
Input voltage	V	-0.5 to 6.0	V			
Output diode current	I _{ok}	-50	mA	V _○ = −0.5 V		
		50	mA	$V_o = V_{cc} + 0.5 \text{ V}$		
Output voltage	V _o	-0.5 to V_{cc} +0	.5 V			
Output current	I _o	±50	mA			
V _{cc} , GND current / pin	I _{CC} or I _{GND}	100	mA			
Storage temperature	Tstg	-65 to +150	°C	_		

Note: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{cc}	1.5 to 5.5	V	Data retention
		2.0 to 5.5	V	At operation
Input / output voltage	V,	0 to 5.5	V	PR, CLR, CK, D
	V _o	0 to V _{cc}	V	Q, \overline{Q}
Operating temperature	Та	-40 to 85	°C	
Output current	I _{OH}	-12	mA	V _{cc} = 2.7 V
		−24 *2	mA	V _{cc} = 3.0 V to 5.5 V
	I _{oL}	12	mA	V _{cc} = 2.7 V
		24 *2	mA	V _{cc} = 3.0 V to 5.5 V
Input rise / fall time *1	t _r , t _f	10	ns/V	

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

2. duty cycle ≤ 50%

Electrical Characteristics

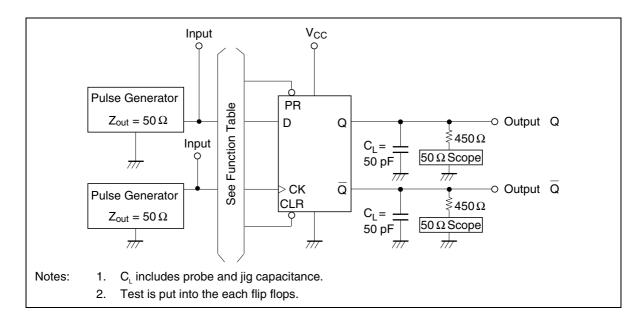
Ta = -40 to 85° C

Item	Symbol	V _{cc} (V)	Min	Max	Unit	Test Conditions
Input voltage	V _{IH}	2.7 to 3.6	2.0	_	V	
		4.5 to 5.5	V _{cc} ×0.7	_	٧	_
	V _{IL}	2.7 to 3.6	_	8.0	٧	
		4.5 to 5.5	_	V _{cc} ×0.3	٧	_
Output voltage	V _{OH}	2.7 to 5.5	V _{cc} -0.2	_	V	$I_{OH} = -100 \ \mu A$
		2.7	2.2	_	٧	I _{OH} = -12 mA
		3.0	2.4	_	٧	_
		3.0	2.0	_	٧	I _{OH} = -24 mA
		4.5	3.8	_	٧	_
	V _{OL}	2.7 to 5.5	_	0.2	٧	I _{OL} = 100 μA
		2.7	_	0.4	V	I _{OL} = 12 mA
		3.0	_	0.55	V	I _{oL} = 24 mA
		4.5	_	0.55	V	_
Input current	I _{IN}	0 to 5.5	_	±5.0	μΑ	V _{IN} = 5.5 V or GND
Quiescent supply current	: I _{cc}	5.5	_	20	μΑ	V _{IN} = V _{CC} or GND
	ΔI_{cc}	3.0 to 3.6	_	500	μA	V_{IN} = one input at $(V_{CC}-0.6)V$, other inputs at V_{CC} or GND

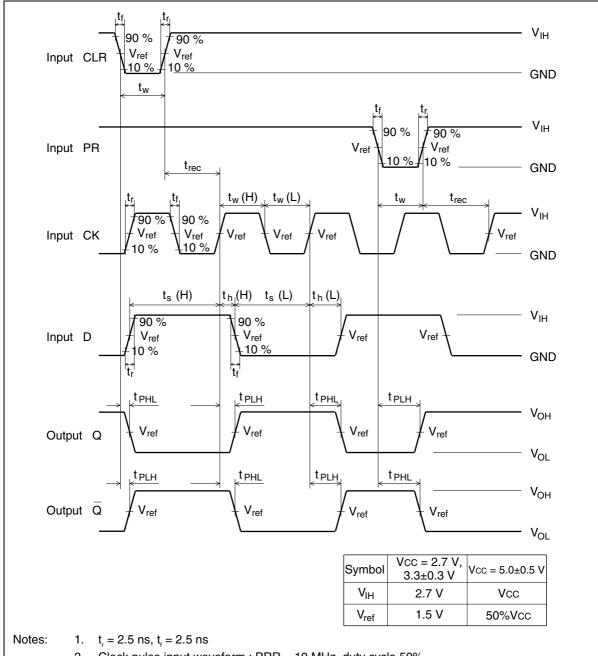
Switching Characteristics

		Ta = -40 to 85°C						
Item	Symbol	V _{cc} (V)	Min	Тур	Max	_ Unit	From (Input)	To (Output)
Maximum clock frequency	f _{max}	2.7	150.0	_	_	MHz		
		3.3±0.3	150.0	_	_	MHz	=	
		5.0±0.5	150.0	_	_	MHz	=	
Propagation delay time	t _{PLH}	2.7	_	6.0	9.0	ns	CLK	Q, Q
	$\mathbf{t}_{_{\mathrm{PHL}}}$	3.3±0.3	1.5	5.0	8.0	ns	-	
		5.0±0.5	_	4.0	6.5	ns	-	
	t _{PLH}	2.7	_	6.5	9.0	ns	PR or CLR	Q, Q
	$\mathbf{t}_{_{\mathrm{PHL}}}$	3.3±0.3	1.5	5.0	8.0	ns	-	
		5.0±0.5	_	4.0	6.5	ns	-	
Setup time	t _{su}	2.7	4.0	_	_	ns	_	
		3.3±0.3	3.0	_	_	ns	<u>-</u>	
		5.0±0.5	3.0	_	_	ns	-	
Hold time	t _h	2.7	2.0	_	_	ns	_	
		3.3±0.3	2.0	_	_	ns	_	
		5.0±0.5	2.0	_	_	ns		
Pulse width	t _w	2.7	4.0	_	_	ns	CK	
		3.3±0.3	4.0	_	_	ns	_	
		5.0±0.5	4.0	_	_	ns	-	
		2.7	6.0	_	_	ns	PR or CLR	
		3.3±0.3	5.0	_	_	ns	<u>-</u>	
		5.0±0.5	4.0	_	_	ns	-	
Recovery time	t _{rec}	2.7	3.0	_	_	ns		
		3.3±0.3	2.0	_	_	ns	_	
		5.0±0.5	2.0	_	_	ns	-	
Input capacitance	C _{IN}	2.7	_	3.0	_	pF		
Output capacitance	C _o	2.7	_	15.0	_	pF		

Test Circuit



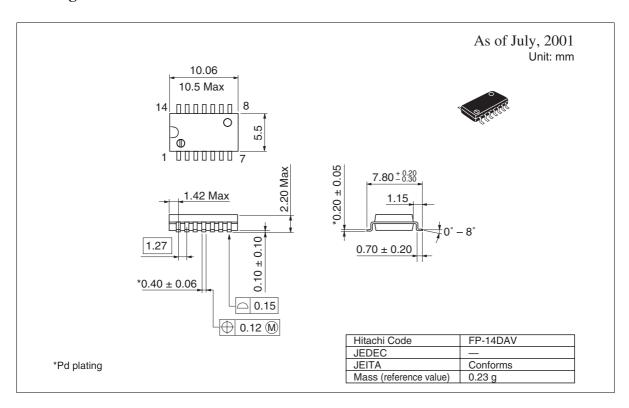
Waveforms

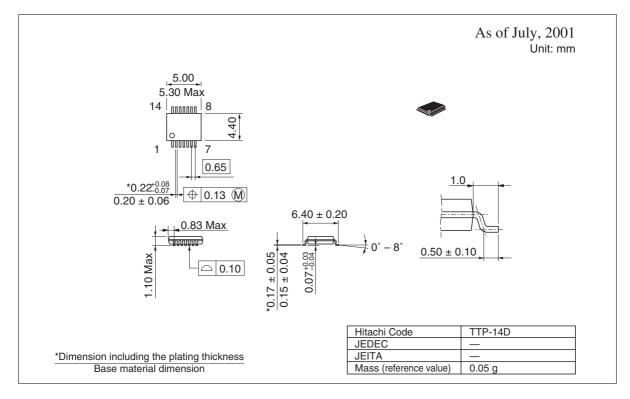


2. Clock pulse input waveform: PRR = 10 MHz, duty cycle 50%

3. Data input waveform: PRR = 5 MHz, duty cycle 50%

Package Dimensions





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